

## MOS FIELD EFFECT TRANSISTOR

# 2SK2141

## SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

#### **DESCRIPTION**

The 2SK2141 is N-channel Power MOS Field Effect Transistor designed for high voltage switching applications.

#### **FEATURES**

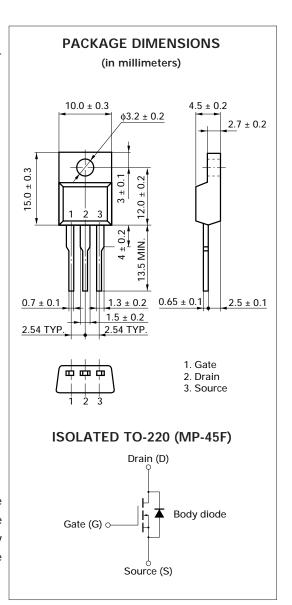
- Low On-state Resistance  $R_{DS(on)} = 1.1 \Omega MAX. (V_{GS} = 10 V, I_{D} = 3.0 A)$
- Low Ciss Ciss = 1150 pF TYP.
- · High Avalanche Capability Ratings
- Isolated TO-220 (MP-45F) Package

### ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage	$V_{\text{DSS}}$	600	V
Gate to Source Voltage	Vgss	±30	V
Drain Current (DC)	D (DC)	±6.0	Α
Drain Current (pulse)	ID (pulse)*	±24	Α
Total Power Dissipation (Tc = 25 °C)	P <sub>T1</sub>	35	W
Total Power Dissipation (Ta = 25 °C)	P <sub>T2</sub>	2.0	W
Storage Temperature	Tstg -55	to +150	°C
Channel Temperature	Tch	150	°C
Single Avalanche Current	las**	6.0	Α
Single Avalanche Energy	Eas**	12	mJ

\*PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1%

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.



<sup>\*\*</sup>Starting T<sub>ch</sub> = 25 °C, R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = 20 V  $\rightarrow$  0

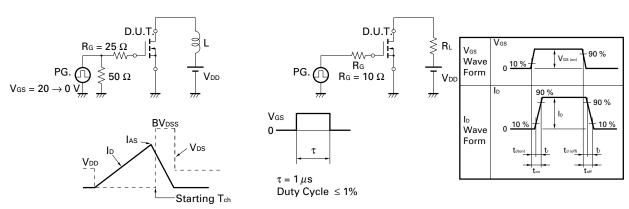


## **ELECTRICAL CHARACTERISTICS (TA = 25 °C)**

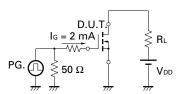
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CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-state Resistance	R <sub>DS(on)</sub>		0.8	1.1	Ω	Vgs = 10 V, ID = 3.0 A
Gate to Source Cutoff Voltage	V <sub>GS(off)</sub>	2.5		3.5	V	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA
Forward Transfer Admittance	yfs	2.0			S	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 3.0 A
Drain Leakage Current	IDSS			100	μΑ	V <sub>DS</sub> = 600V, V <sub>GS</sub> = 0
Gate to Source Leakage Current	Igss			±100	nA	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0$
Input Capacitance	Ciss		1150		pF	V <sub>DS</sub> = 10 V
Output Capacitance	Coss		260		pF	Vgs = 0
Reverse Transfer Capacitance	Crss		60		pF	f = 1 MHz
Turn-On Delay Time	td(on)		15		ns	Vgs = 10 V
Rise Time	tr		15		ns	V <sub>DD</sub> = 150 V
Turn-Off Delay Time	td(off)		75		ns	$I_D = 3.0 \text{ A, Rg} = 10 \Omega$
Fall Time	tf		13		ns	R <sub>L</sub> = 37.5 Ω
Total Gate Charge	Q <sub>G</sub>		40		nC	Vgs = 10 V
Gate to Source Charge	Qgs		6.0		nC	ID = 6.0 A
Gate to Drain Charge	Q <sub>GD</sub>		20		nC	V <sub>DD</sub> = 480 V
Diode Forward Voltage	V <sub>F</sub> (S-D)		1.0		V	IF = 6.0 A, VGS = 0
Reverse Recovery Time	trr		370		ns	IF = 6.0 A
Reverse Recovery Charge	Qrr		1.5		μC	di/dt = 50 A/μs

## **Test Circuit 1: Avalanche Capability**

## **Test Circuit 2: Switching Time**



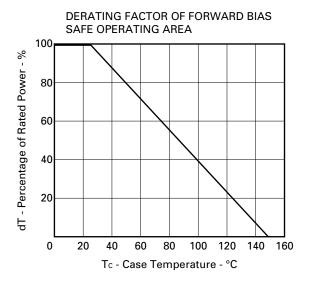
### **Test Circuit 3: Gate Charge**



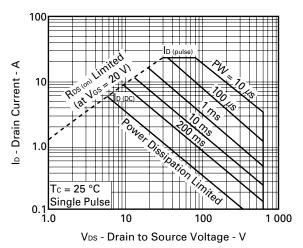
The application circuits and their parameters are for references only and are not intended for use in actual design-in's.



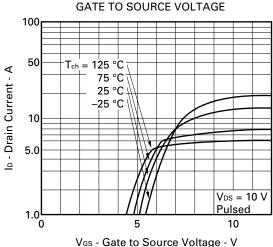
#### TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C)

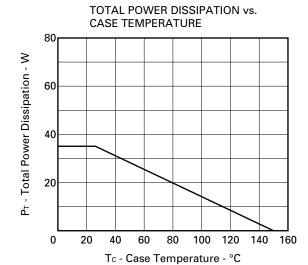


#### FORWARD BIAS SAFE OPERATING AREA

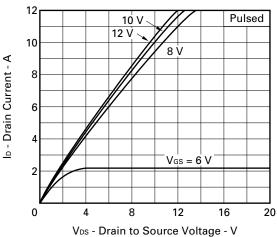


DRAIN CURRENT vs.

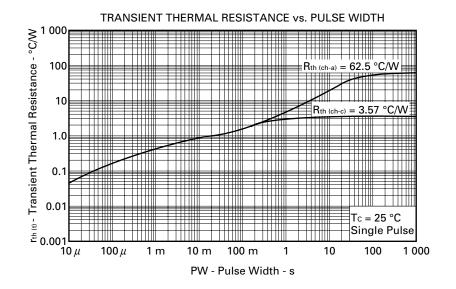


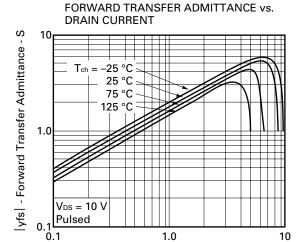


DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE





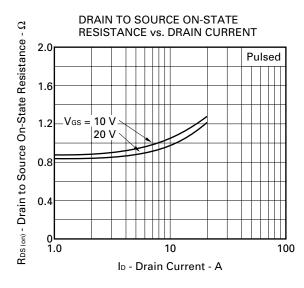


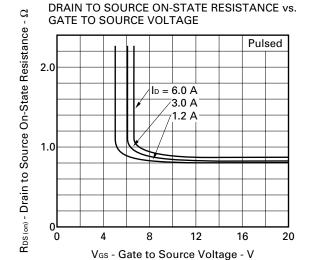


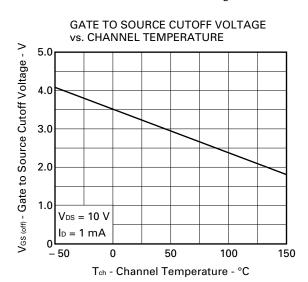
1.0

ID - Drain Current - A

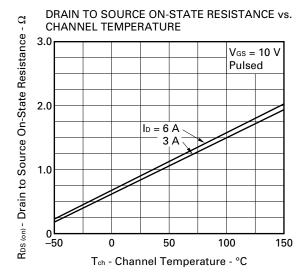
10

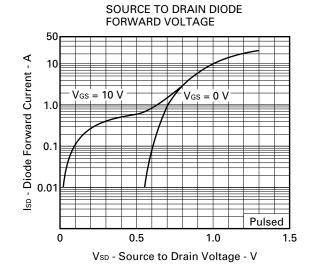


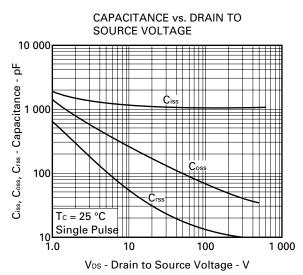


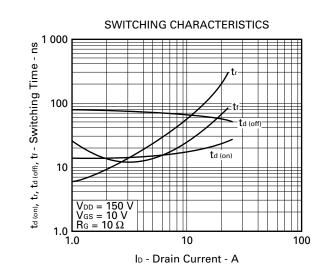


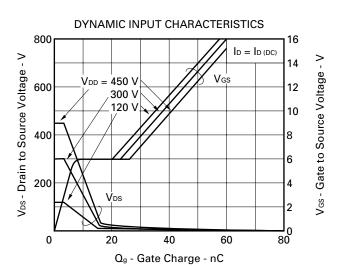


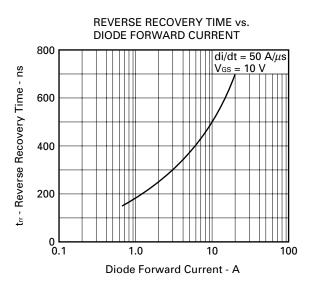








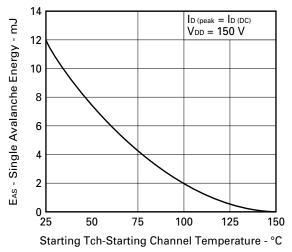






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## SINGLE AVALANCHE ENERGY vs. STARTING CHANNEL TEMPERATURE





## REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

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Anti-radioactive design is not implemented in this product.

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